ASSOCIATION CONNECTING ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® international and Pa	PC. Bannockt	ourn. Illinois. A	Il rights reserved un ntions.	nder both	This docum level parts, t	ent is a declaratio the declaration en	n of the substanc compasses all lo	es within the manufactur wer level materials for w	rer listed it hich the m	em. Note: if anufacturer	the item is an as has engineering	sembly with low responsibility.	
					Yype * Declaration Class *   ute Class 6 - RoHS Yes/No, Homogeneous Materi				als and Mfg Information				
Supplier Information													
Company name* Comp			Company unique ID			Unique ID Authority				Response Date*			
onsemi										2023-06-08			
Contact Name Title - Contact			act		Phone - Contact*			Email - Contact*					
Product-Env-Stewards Product Env			t Enviro Compliance		NA			Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Repres			presentative		Phone - Representative*			Email - Representative*					
Product-Env-Stewards Product En			uct Enviro Compliance			NA			Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	Manufacturing Site	1	Weight*	UOM	Unit Type	
	NCV866	NCV8664ST50T3G ANA		ANA ULTRA LOW IQ LDO		2023-06-08		MY1		.09.99	mg	Each	
Anufacturing Proccess Informa	tion		·			·							
Terminal Plating / Grid Array M	lating / Grid Array Material Terminal Base		Alloy J	-STD-020 MSL	Rating	Peak Proces	s Body Tempera	ture Max Time at Peak	Temperat	ure Numb	er of Reflow Cyc	les	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy	3			260	С	30	secon	ds 3			
omments													
<b>TTENTION: MSL 3 Rated item require</b>	es Bake and D	ry Pack (after	electrical test)										
or more information regarding material	composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.3	mg	Supplier	Silicon (Si)	7440-21-3		3.3	mg
Die Attach	2.37	mg	Supplier	Silver (Ag)	7440-22-4		1.7775	mg
			Supplier	Epoxy resins	129915-35-1		0.5925	mg
Lead Frame	37.17	mg	Supplier	Silver (Ag)	7440-22-4		0.4832	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0372	mg
			Supplier	Iron (Fe)	7439-89-6		0.8921	mg
			Supplier	Copper (Cu)	7440-50-8		35.7575	mg
Mold Compound-Black	59.7	mg		Epoxy Phenol Resin	proprietary data		5.373	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2985	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		52.2076	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.8209	mg
Plating	7.44	mg	Supplier	Tin (Sn)	7440-31-5		7.44	mg
Wire Bond - Au	0.01	mg	Supplier	Gold (Au)	7440-57-5		0.01	mg